

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shinji NISHIKAWA</td> <td>06/07/2012</td> </tr> <tr> <td>Takenori HIROKI</td> <td>06/07/2012</td> </tr> <tr> <td>Kouji ISHIKAWA</td> <td>06/07/2012</td> </tr> <tr> <td>Manabu EDAMURA</td> <td>06/07/2012</td> </tr> <tr> <td>Hidetoshi SATAKE</td> <td>06/07/2012</td> </tr> <tr> <td>Takatoshi OOKI</td> <td>06/07/2012</td> </tr> </tbody> </table>	Name	Execution Date	Shinji NISHIKAWA	06/07/2012	Takenori HIROKI	06/07/2012	Kouji ISHIKAWA	06/07/2012	Manabu EDAMURA	06/07/2012	Hidetoshi SATAKE	06/07/2012	Takatoshi OOKI	06/07/2012	
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Takatoshi OOKI	06/07/2012														
RECEIVING PARTY DATA															
Name:	HITACHI CONSTRUCTION MACHINERY CO., LTD.														
Street Address:	5-1, Koraku 2-chome, Bunkyo-ku														
City:	Tokyo														
State/Country:	JAPAN														
Postal Code:	112-8563														
PROPERTY NUMBERS Total: 1															
Property Type	Number														
Application Number:	13642621														
CORRESPONDENCE DATA															
Fax Number:	7036841157														
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NAME OF SUBMITTER:	John R. Mattingly														
Total Attachments: 1 source=8539-Assign#page1.tif															

OP \$40.00 13642621

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI CONSTRUCTION MACHINERY CO., LTD., a corporation organized under the laws of Japan, located at 5-1, Koraku 2-chome, Bunkyo-ku, Tokyo 112-8563 Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to HYBRID CONSTRUCTION MACHINE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI CONSTRUCTION MACHINERY CO., LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI CONSTRUCTION MACHINERY CO., LTD.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Shinji NISHIKAWA</u> Shinji NISHIKAWA	<u>6/7/2012</u>
2) <u>Takenori Hiroki</u> Takenori HIROKI	<u>6/7/2012</u>
3) <u>Kouji Ishikawa</u> Kouji ISHIKAWA	<u>6/7/2012</u>
4) <u>Manabu Edamura</u> Manabu EDAMURA	<u>6/7/2012</u>
5) <u>Hidetoshi Satake</u> Hidetoshi SATAKE	<u>6/7/2012</u>
6) <u>Takatoshi OOKI</u> Takatoshi OOKI	<u>6/7/2012</u>
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

PATENT